Main design parameters for SuperFGD electronics E. Noah Draft 02-May-18

Level 1	Level 2	Level 3	Unit	Nominal	Minimum	Maximum
System	Basic parameters	Number of channels	[]	60000		100000
		Cost(total)/channel	[JPY/channel]	1000		
		Power requirements	[W]	1000		2000
Beam	Bunches per spill			8		
	Bunch width		[ns]	80		
	Bunch-to-Bunch separation		[ns]	600		
	Spill duration		[µs]	5		
	Spill rate 2018 (run 9)		[Hz]	0.4		
	Spill rate for design		[Hz]	0.8		
	Beam power 2018 (run 9)		[kW]	500		
	Beam power for design		[kW]	1500		
Scintillator	Typical light yield		[pe/MIP/cm]	40	10	) 100
	Crosstalk per side for 1 cube		[%/side]	3.7		
	Crosstalk for 1 cube		[%/cube]	22		
MPPC (\$13360-1325PE)	Number of nixels		[]	2668		
Will C (313300-1323) E)	Operating voltage		[V]	58	53	63
	Gain		[*]	50		, 05
	PDE		[^ 10 ]	, 25		
	Pork count	at 0 E no thrashold	[/0] [U=1	70000		
	Dark count	1 C no threshold	[[]2]	70000		
		2.5 pe threshold	[[12]			
200	A 11.1 11	2.5 pe threshold	[HZ]			
RUL	Acquisition window per spill		[µs]	20	10	)
	Deadtime during acquisition window		[S]	0		
	Repetition rate		[Hz]	0.8		2
	Hit amplitude	Dynamic range	[pe]	1000	500	)
		Dynamic range (MPPC Gain=7e5)	[pC]	112		
		Detection threshold	[pe]	0.5		
		Detection threshold (MPPC Gain=7e5	5[fC]	56		
		Noise	[pe/noise ratio]	5		
	Hit time	Hits time sampling rate	[GHz]	1	0.4	4 5
		Trigger capability	[pe]	0.5		
	Synchronisation	Jitter (self-SuperFGD FEE only)	[ns]	10		
		Jitter (w.r.t other ND280 electronics)	[ns]	10		
		Jitter (w.r.t T2K beam)	[ns]	10		
	Event rate (threshold at 0.5 p.e.)	Hits per channel per spill	[/ch/spill]	0.01		
		Hits per channel per spill (noise)	[/ch/spill]	2		
		Hits per ROC per spill	[/ROC/spill]	100		
Material budget	ROC board + FEE	ROC fractional radiation length	[x/X0]	10		
	Conectivity (board/flex/cables)	Cabling fractional radiation length	[x/X0]	10		
Environmental condition	Altitude			0		
	Temperature	Operating	[°C]		5	5 35
		Safe	[°C]		C	40
		Transport and storage	[°C]		C	40
	Pressure	Operating		Atmospheric		
		Safe				
		Transport and storage				
	Humidity	Operating	[%HR]		10	30
		Safe	[%HR]		10	40
		Transport and storage	[%HR]		10	40
	Shocks and vibrations	Operating	[]			
		Transport				
	Radiation magnetic and electric	Radiation		0		
	haddelon, magnetie and electric	Magnetic field (IIA1)	[T]	0.2	C	0.5
		SiPM Von	[1]	50		) 0.5
Life term	Test/qualification phase	эн үү үүр	[months]	50	(	
	Experiment phase		[months]	2	l	, 0
	Experiment pridse		[yedis]	20		
Device concention	Expected operation fraction	Der shannel DOC		4000		
Power consumption		Per charnel KUC		10		
		Per channel total	[mW]	15		